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Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

Details

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Product Status	Active
Core Processor	MIPS32® M4K™
Core Size	32-Bit Single-Core
Speed	50MHz
Connectivity	I ² C, IrDA, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, DMA, I ² S, POR, PWM, WDT
Number of I/O	35
Program Memory Size	256KB (256K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	64K x 8
Voltage - Supply (Vcc/Vdd)	2.3V ~ 3.6V
Data Converters	A/D 13x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	44-TQFP
Supplier Device Package	44-TQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic32mx170f256d-50i-pt

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

		Pin Nu	mber ⁽¹⁾			-	
Pin Name	28-pin QFN	28-pin SSOP/ SPDIP/ SOIC	36-pin VTLA	44-pin QFN/ TQFP/ VTLA	Pin Type	Buffer Type	Description
RC0	—	—	3	25	I/O	ST	PORTC is a bidirectional I/O port
RC1	—	—	4	26	I/O	ST	
RC2	—	—	_	27	I/O	ST	
RC3	—	—	11	36	I/O	ST	_
RC4	—	—	_	37	I/O	ST	_
RC5	—			38	I/O	ST	_
RC6		—	_	2	I/O	ST	_
RC7	—		—	3	I/O	ST	4
RC8	—	—	—	4	I/O	ST	_
RC9		- 40	20	5	I/O	ST	Time and an element all all in must
T1CK T2CK	9 PPS	12	10	34		ST	Timer1 external clock input
T3CK	PPS PPS	PPS PPS	PPS PPS	PPS PPS		ST ST	Timer2 external clock input Timer3 external clock input
T4CK	PPS	PPS	PPS	PPS	1	ST	Timer4 external clock input
T5CK	PPS	PPS	PPS	PPS		ST	Timer5 external clock input
	PPS	PPS	PPS	PPS		ST	UART1 clear to send
U1RTS	PPS	PPS	PPS	PPS		51	
U1RX	PPS PPS	PPS PPS	PPS PPS	PPS PPS	0	ST	UART1 ready to send UART1 receive
U1TX	PPS	PPS	PPS	PPS	-		
					0		UART1 transmit
U2CTS	PPS	PPS	PPS	PPS	I	ST	UART2 clear to send
U2RTS	PPS	PPS	PPS	PPS	0		UART2 ready to send
U2RX	PPS	PPS	PPS	PPS	I	ST	UART2 receive
U2TX	PPS	PPS	PPS	PPS	0		UART2 transmit
SCK1	22	25	28	14	I/O	ST	Synchronous serial clock input/output for SPI1
SDI1	PPS	PPS	PPS	PPS	I	ST	SPI1 data in
SDO1	PPS	PPS	PPS	PPS	0	_	SPI1 data out
SS1	PPS	PPS	PPS	PPS	I/O	ST	SPI1 slave synchronization or frame pulse I/O
SCK2	23	26	29	15	I/O	ST	Synchronous serial clock input/output for SPI2
SDI2	PPS	PPS	PPS	PPS		ST	SPI2 data in
SDO2	PPS	PPS	PPS	PPS	0	_	SPI2 data out
SS2	PPS	PPS	PPS	PPS	I/O	ST	SPI2 slave synchronization or frame pulse I/O
SCL1	14	17	18	44	I/O	ST	Synchronous serial clock input/output for I2C1
	ST = Schm TTL = TTL	MOS compa itt Trigger in input buffer	put with CN	MOS levels		O = Outp PPS = P	Analog input P = Power

Note 1: Pin numbers are provided for reference only. See the "Pin Diagrams" section for device pin availability.

2: Pin number for PIC32MX1XX devices only.

3: Pin number for PIC32MX2XX devices only.

NOTES:

8.0 OSCILLATOR CONFIGURATION

Note:	This data sheet summarizes the features of the PIC32MX1XX/2XX 28/36/44-pin Family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data								
	sheet, refer to Section 6. "Oscillator								
	Configuration" (DS60001112), which is								
	available from the Documentation >								
	Reference Manual section of the								
	Microchip PIC32 web site								
	(www.microchip.com/pic32).								

The PIC32MX1XX/2XX 28/36/44-pin Family oscillator system has the following modules and features:

- Four external and internal oscillator options as clock sources
- On-Chip PLL with user-selectable input divider, multiplier and output divider to boost operating frequency on select internal and external oscillator sources
- On-Chip user-selectable divisor postscaler on select oscillator sources
- Software-controllable switching between various clock sources
- A Fail-Safe Clock Monitor (FSCM) that detects clock failure and permits safe application recovery or shutdown
- Dedicated On-Chip PLL for USB peripheral

A block diagram of the oscillator system is provided in Figure 8-1.

REGISTER 9-4: DCRCCON: DMA CRC CONTROL REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit Bit 29/21/13/5 28/20/12/4		Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0				
04.04	U-0	U-0	R/W-0	R/W-0	R/W-0	U-0	U-0	R/W-0				
31:24	—	_	BYTC	<1:0>	WBO ⁽¹⁾	—	_	BITO				
22:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0				
23:16	—	_	—	_	—	—	_	_				
45.0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0				
15:8		_	_	PLEN<4:0>								
7.0	R/W-0	R/W-0	R/W-0	U-0	U-0	R/W-0	R/W-0	R/W-0				
7:0	CRCEN	CRCAPP ⁽¹⁾	CRCTYP	_	_	(CRCCH<2:0>					

Legend:

Logona.			
R = Readable bit	W = Writable bit	U = Unimplemented bit, r	ead as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-30 Unimplemented: Read as '0'

- bit 29-28 BYTO<1:0>: CRC Byte Order Selection bits
 - 11 = Endian byte swap on half-word boundaries (i.e., source half-word order with reverse source byte order per half-word)
 - 10 = Swap half-words on word boundaries (i.e., reverse source half-word order with source byte order per half-word)
 - 01 = Endian byte swap on word boundaries (i.e., reverse source byte order)
 - 00 = No swapping (i.e., source byte order)
- bit 27 **WBO:** CRC Write Byte Order Selection bit⁽¹⁾
 - 1 = Source data is written to the destination re-ordered as defined by BYTO<1:0>
 - 0 = Source data is written to the destination unaltered
- bit 26-25 Unimplemented: Read as '0'
- bit 24 BITO: CRC Bit Order Selection bit

When CRCTYP (DCRCCON<15>) = 1 (CRC module is in IP Header mode):

- 1 = The IP header checksum is calculated Least Significant bit (LSb) first (i.e., reflected)
- 0 = The IP header checksum is calculated Most Significant bit (MSb) first (i.e., not reflected)

<u>When CRCTYP (DCRCCON<15>) = 0</u> (CRC module is in LFSR mode):

- 1 = The LFSR CRC is calculated Least Significant bit first (i.e., reflected)
- 0 = The LFSR CRC is calculated Most Significant bit first (i.e., not reflected)

bit 23-13 Unimplemented: Read as '0'

bit 12-8 **PLEN<4:0>:** Polynomial Length bits

<u>When CRCTYP (DCRCCON<15>) = 1</u> (CRC module is in IP Header mode): These bits are unused.

<u>When CRCTYP (DCRCCON<15>) = 0</u> (CRC module is in LFSR mode): Denotes the length of the polynomial -1.

- bit 7 CRCEN: CRC Enable bit
 - 1 = CRC module is enabled and channel transfers are routed through the CRC module
 - 0 = CRC module is disabled and channel transfers proceed normally
- Note 1: When WBO = 1, unaligned transfers are not supported and the CRCAPP bit cannot be set.

REGISTE	REGISTER 9-8: DCHXECON: DMA CHANNEL X EVENT CONTROL REGISTER										
Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0			
24.24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0			
31:24	_	—	—	_	—	_	—	—			
22:40	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1			
23:16	CHAIRQ<7:0> ⁽¹⁾										
15:0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1			
15:8	CHSIRQ<7:0> ⁽¹⁾										
7:0	S-0	S-0	R/W-0	R/W-0	R/W-0	U-0	U-0	U-0			
7.0	CFORCE	CABORT	PATEN	SIRQEN	AIRQEN						

CISTER 0-8. CIETED

Legend:	S = Settable bit		
R = Readable bit	W = Writable bit	U = Unimplemented b	it, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-24 Unimplemented: Read as '0'

bit

bit

bit

bit

bit

bit

: 31-24	Unimplemented: Read as '0'
23-16	CHAIRQ<7:0>: Channel Transfer Abort IRQ bits ⁽¹⁾
	11111111 = Interrupt 255 will abort any transfers in progress and set CHAIF flag
	•
	•
	•
	00000001 = Interrupt 1 will abort any transfers in progress and set CHAIF flag 00000000 = Interrupt 0 will abort any transfers in progress and set CHAIF flag
15-8	CHSIRQ<7:0>: Channel Transfer Start IRQ bits ⁽¹⁾
	11111111 = Interrupt 255 will initiate a DMA transfer
	•
	•
	•
	00000001 = Interrupt 1 will initiate a DMA transfer
_	0000000 = Interrupt 0 will initiate a DMA transfer
:7	CFORCE: DMA Forced Transfer bit
	 1 = A DMA transfer is forced to begin when this bit is written to a '1' 0 = This bit always reads '0'
6	CABORT: DMA Abort Transfer bit
	1 = A DMA transfer is aborted when this bit is written to a '1'
	0 = This bit always reads '0'
5	PATEN: Channel Pattern Match Abort Enable bit
	1 = Abort transfer and clear CHEN on pattern match
	0 = Pattern match is disabled
: 4	SIRQEN: Channel Start IRQ Enable bit
	1 = Start channel cell transfer if an interrupt matching CHSIRQ occurs

- - 0 = Interrupt number CHSIRQ is ignored and does not start a transfer
- bit 3 AIRQEN: Channel Abort IRQ Enable bit
 - 1 = Channel transfer is aborted if an interrupt matching CHAIRQ occurs
 - 0 = Interrupt number CHAIRQ is ignored and does not terminate a transfer
- bit 2-0 Unimplemented: Read as '0'
- Note 1: See Table 7-1: "Interrupt IRQ, Vector and Bit Location" for the list of available interrupt IRQ sources.

REGIST												
Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0				
21.24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0				
31:24	-	—	—	-	-	—	-	—				
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0				
23.10	-	—	—	-	-	—	-	—				
15:8	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0				
15.6		_	-			—		—				
7.0	R/WC-0, HS	U-0	R/WC-0, HS									
7:0	IDIF	T1MSECIF	LSTATEIF	ACTVIF	SESVDIF	SESENDIF		VBUSVDIF				

REGISTER 10-1: U1OTGIR: USB OTG INTERRUPT STATUS REGISTER

Legend:	WC = Write '1' to clear	HS = Hardware Settable bit				
R = Readable bit	W = Writable bit	U = Unimplemented bit, re	ead as '0'			
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown			

bit 31-8 Unimplemented: Read as '0'

- bit 7 **IDIF:** ID State Change Indicator bit
 - 1 = A change in the ID state was detected
 - 0 = No change in the ID state was detected
- bit 6 T1MSECIF: 1 Millisecond Timer bit
 - 1 = 1 millisecond timer has expired
 - 0 = 1 millisecond timer has not expired

bit 5 LSTATEIF: Line State Stable Indicator bit

- 1 = USB line state has been stable for 1 ms, but different from last time
- 0 = USB line state has not been stable for 1 ms
- bit 4 ACTVIF: Bus Activity Indicator bit
 - 1 = Activity on the D+, D-, ID or VBUS pins has caused the device to wake-up
 - 0 = Activity has not been detected
- bit 3 SESVDIF: Session Valid Change Indicator bit
 - 1 = VBUS voltage has dropped below the session end level
 - 0 = VBUS voltage has not dropped below the session end level
- bit 2 SESENDIF: B-Device VBUS Change Indicator bit
 - 1 = A change on the session end input was detected
 - 0 = No change on the session end input was detected
- bit 1 Unimplemented: Read as '0'
- bit 0 VBUSVDIF: A-Device VBUS Change Indicator bit
 - 1 = A change on the session valid input was detected
 - 0 = No change on the session valid input was detected

TABLE 11-5: PORTC REGISTER MAP

ess	-											Bits							
Virtual Address (BF88_#)	Register Name ^(1,2)	Bit Range	31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	19/3	18/2	17/1	16/0	All Resets
6200	ANSELC	31:16		_			—	—	_	-	_	-	_	_	—	_	—		0000
0200	,	15:0	—	—	—	—	—	—			—			_	ANSC3(4)	ANSC2 ⁽³⁾	ANSC1	ANSC0	000F
6210	TRISC	31:16	_	_	—	—	—	—	—	—	—	—	—	—	—	—	—		0000
0210	11100	15:0	_	_	—	—	—	—	TRISC9	TRISC8 ⁽³⁾	TRISC7 ⁽³⁾	TRISC6 ⁽³⁾	TRISC5 ⁽³⁾	TRISC4 ⁽³⁾	TRISC3	TRISC2 ⁽³⁾	TRISC1	TRISC0	03FF
6220	PORTC	31:16	—	—	—	—	—	—	_		_		_						0000
0220		15:0	_	_	—	—	—	—	RC9	RC8 ⁽³⁾	RC7 ⁽³⁾	RC6 ⁽³⁾	RC5 ⁽³⁾	RC4 ⁽³⁾	RC3	RC2 ⁽³⁾	RC1	RC0	xxxx
6230	LATC	31:16	_	_	—	—	—	—	_		_			_	—		—	—	0000
0230	LAIC	15:0			_	_	_	_	LATC9	LATC8 ⁽³⁾	LATC7 ⁽³⁾	LATC6 ⁽³⁾	LATC5 ⁽³⁾	LATC4 ⁽³⁾	LATC3	LATC2 ⁽³⁾	LATC1	LATC0	xxxx
6240	ODCC	31:16			_	_	_	_	_						_		_	_	0000
6240	ODCC	15:0			_	_	_	_	ODCC9	ODCC8 ⁽³⁾	ODCC7 ⁽³⁾	ODCC6 ⁽³⁾	ODCC5 ⁽³⁾	ODCC4 ⁽³⁾	ODCC3	ODCC2 ⁽³⁾	ODCC1	ODCC0	0000
0050		31:16			—	—	—	-	—	-	_	-	—	—	—	—	—	—	0000
6250	CNPUC	15:0	_	_	_	_	—	—	CNPUC9	CNPUC8 ⁽³⁾	CNPUC7 ⁽³⁾	CNPUC6 ⁽³⁾	CNPUC5 ⁽³⁾	CNPUC4 ⁽³⁾	CNPUC3	CNPUC2 ⁽³⁾	CNPUC1	CNPUC0	0000
0000		31:16	_	_	_	_	_	_	—	_	_	_	_	—	_	—	_	_	0000
6260	CNPDC	15:0	_	_	—	—	—	—	CNPDC9	CNPDC8 ⁽³⁾	CNPDC7 ⁽³⁾	CNPDC6 ⁽³⁾	CNPDC5 ⁽³⁾	CNPDC4 ⁽³⁾	CNPDC3	CNPDC2 ⁽³⁾	CNPDC1	CNPDC0	0000
0070	anaana	31:16	_	_	—	—	—	—	_	_	_	_	—	—	—	_	—	—	0000
6270	CNCONC	15:0	ON	_	SIDL	_	—	—	_	_	_	_	_	—	—	_	—	_	0000
		31:16	_	_	_		—	_			_		_	_	_	_	—	—	0000
6280	CNENC	15:0	_	_	_		—	_	CNIEC9	CNIEC8(3)	CNIEC7 ⁽³⁾	CNIEC6(3)	CNIEC5 ⁽³⁾	CNIEC4 ⁽³⁾	CNIEC3	CNIEC2 ⁽³⁾	CNIEC1	CNIEC0	0000
		31:16	_	_	_	_	_	_	_		_		_	_	—		—	—	0000
6290	CNSTATC	15:0	_	_	_	_	_	_	CNSTATC9	CNSTATC8(3)	CNSTATC7 ⁽³⁾	CNSTATC6(3)	CNSTATC5(3)	CNSTATC4 ⁽³⁾	CNSTATC3	CNSTATC2(3)	CNSTATC1	CNSTATC0	0000

Legend: x = unknown value on Reset; - = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: All registers in this table have corresponding CLR, SET and INV registers at their virtual addresses, plus offsets of 0x4, 0x8 and 0xC, respectively. See Section 11.2 "CLR, SET and INV Registers" for more information.

2: PORTC is not available on 28-pin devices.

3: This bit is only available on 44-pin devices.

4: This bit is only available on USB-enabled devices with 36 or 44 pins.

REGISTER 17-2: SPIxCON2: SPI CONTROL REGISTER 2

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
21.24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31:24	—	—	—	—	—	—	_	—
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23.10	—	—	—	—	—	—	_	—
15:8	R/W-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
10.0	SPISGNEXT	—	—	FRMERREN	SPIROVEN	SPITUREN	IGNROV	IGNTUR
7:0	R/W-0	U-0	U-0	U-0	R/W-0	U-0	R/W-0	R/W-0
7:0	AUDEN ⁽¹⁾	_	_	—	AUDMONO ^(1,2)	—	AUDMOD)<1:0> ^(1,2)

Legend:

R = Readable bit	Readable bit W = Writable bit		as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-16 Unimplemented: Read as '0'

- bit 15 SPISGNEXT: Sign Extend Read Data from the RX FIFO bit
 - 1 = Data from RX FIFO is sign extended
 - 0 = Data from RX FIFO is not sign extended
- bit 14-13 Unimplemented: Read as '0'
- bit 12 **FRMERREN:** Enable Interrupt Events via FRMERR bit
 - 1 = Frame Error overflow generates error events
 - 0 = Frame Error does not generate error events
- bit 11 SPIROVEN: Enable Interrupt Events via SPIROV bit
 - 1 = Receive overflow generates error events
 - 0 = Receive overflow does not generate error events
- bit 10 SPITUREN: Enable Interrupt Events via SPITUR bit
 - 1 = Transmit underrun generates error events
 - 0 = Transmit underrun does not generate error events
- bit 9 IGNROV: Ignore Receive Overflow bit (for Audio Data Transmissions)
 - 1 = A ROV is not a critical error; during ROV data in the FIFO is not overwritten by receive data
 0 = A ROV is a critical error that stops SPI operation
- bit 8 **IGNTUR:** Ignore Transmit Underrun bit (for Audio Data Transmissions)
 - 1 = A TUR is not a critical error and zeros are transmitted until the SPIxTXB is not empty
 - 0 = A TUR is a critical error that stops SPI operation
- bit 7 AUDEN: Enable Audio CODEC Support bit⁽¹⁾
- 1 = Audio protocol enabled
 - 0 = Audio protocol disabled
- bit 6-5 Unimplemented: Read as '0'
- bit 3 AUDMONO: Transmit Audio Data Format bit^(1,2)
 - 1 = Audio data is mono (Each data word is transmitted on both left and right channels)
 - 0 = Audio data is stereo
- bit 2 Unimplemented: Read as '0'
- bit 1-0 AUDMOD<1:0>: Audio Protocol Mode bit^(1,2)
 - 11 = PCM/DSP mode
 - 10 = Right-Justified mode
 - 01 = Left-Justified mode
 - $00 = I^2S \mod$
- **Note 1:** This bit can only be written when the ON bit = 0.
 - **2:** This bit is only valid for AUDEN = 1.

REGISTER 19-1: UXMODE: UARTX MODE REGISTER (CONTINUED)

bit 5	 ABAUD: Auto-Baud Enable bit 1 = Enable baud rate measurement on the next character – requires reception of Sync character (0x55); cleared by hardware upon completion 0 = Baud rate measurement disabled or completed
bit 4	RXINV: Receive Polarity Inversion bit 1 = UxRX Idle state is '0' 0 = UxRX Idle state is '1'
bit 3	BRGH: High Baud Rate Enable bit 1 = High-Speed mode – 4x baud clock enabled 0 = Standard Speed mode – 16x baud clock enabled
bit 2-1	PDSEL<1:0>: Parity and Data Selection bits 11 = 9-bit data, no parity 10 = 8-bit data, odd parity 01 = 8-bit data, even parity 00 = 8-bit data, no parity
bit 0	STSEL: Stop Selection bit 1 = 2 Stop bits 0 = 1 Stop bit

Note 1: When using 1:1 PBCLK divisor, the user software should not read/write the peripheral SFRs in the SYSCLK cycle immediately following the instruction that clears the module's ON bit.

REGISTER 22-3: AD1CON3: ADC CONTROL REGISTER 3

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0		
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0		
	—	—	—	_	—	—	—	-		
00.10	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0		
23:16	—	—	—	_	—	—	_	-		
45.0	R/W-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0		
15:8	ADRC	_	—			SAMC<4:0>(1)				
7.0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W	R/W-0		
7:0				ADCS<	7:0> (2)		I			

Legend:

=ogona.			
R = Readable bit	W = Writable bit	U = Unimplemented bit, re	ead as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-16 Unimplemented: Read as '0'

- bit 15 ADRC: ADC Conversion Clock Source bit
 - 1 = Clock derived from FRC
 - 0 = Clock derived from Peripheral Bus Clock (PBCLK)
- bit 14-13 Unimplemented: Read as '0'
- - 00000001 =TPB • 2 • (ADCS<7:0> + 1) = 4 • TPB = TAD 00000000 =TPB • 2 • (ADCS<7:0> + 1) = 2 • TPB = TAD
- **Note 1:** This bit is only used if the SSRC<2:0> bits (AD1CON1<7:5>) = 111.
 - 2: This bit is not used if the ADRC (AD1CON3<15>) bit = 1.

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
51.24	EDG1MOD	EDG1POL		EDG1S	EDG2STAT	EDG1STAT		
23:16	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0	U-0
23.10	EDG2MOD	EDG2POL		EDG2S	—	—		
15:8	R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
15.0	ON	—	CTMUSIDL	TGEN ⁽¹⁾	EDGEN	EDGSEQEN	IDISSEN ⁽²⁾	CTTRIG
7:0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
7.0			ITRIM	1<5:0>			IRNG<1:0	<1:0>

REGISTER 25-1: CTMUCON: CTMU CONTROL REGISTER

Legend:

Logona.					
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'			
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown		

- bit 31 EDG1MOD: Edge1 Edge Sampling Select bit
 - 1 = Input is edge-sensitive
 - 0 = Input is level-sensitive
- bit 30 EDG1POL: Edge 1 Polarity Select bit
 - 1 = Edge1 programmed for a positive edge response
 - 0 = Edge1 programmed for a negative edge response
- bit 29-26 EDG1SEL<3:0>: Edge 1 Source Select bits
 - 1111 = C3OUT pin is selected
 - 1110 = C2OUT pin is selected
 - 1101 = C1OUT pin is selected
 - 1100 = IC3 Capture Event is selected
 - 1011 = IC2 Capture Event is selected
 - 1010 = IC1 Capture Event is selected
 - 1001 = CTED8 pin is selected
 - 1000 = CTED7 pin is selected
 - 0111 = CTED6 pin is selected
 - 0110 = CTED5 pin is selected
 - 0101 = CTED4 pin is selected
 - 0100 = CTED3 pin is selected
 - 0011 = CTED1 pin is selected
 - 0010 = CTED2 pin is selected
 - 0001 = OC1 Compare Event is selected 0000 = Timer1 Event is selected

bit 25 EDG2STAT: Edge2 Status bit

Indicates the status of Edge2 and can be written to control edge source

- 1 = Edge2 has occurred
- 0 = Edge2 has not occurred
- Note 1: When this bit is set for Pulse Delay Generation, the EDG2SEL<3:0> bits must be set to '1110' to select C2OUT.
 - 2: The ADC module Sample and Hold capacitor is not automatically discharged between sample/conversion cycles. Software using the ADC as part of a capacitive measurement, must discharge the ADC capacitor before conducting the measurement. The IDISSEN bit, when set to '1', performs this function. The ADC module must be sampling while the IDISSEN bit is active to connect the discharge sink to the capacitor array.
 - 3: Refer to the CTMU Current Source Specifications (Table 30-41) in Section 30.0 "Electrical Characteristics" for current values.
 - 4: This bit setting is not available for the CTMU temperature diode.

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0	
31:24	r-1	r-1	r-1	r-1	r-1	r-1	R/P	R/P	
	—	_	_	_	—	—	FWDTWINSZ<1:0>		
00.40	R/P	R/P	r-1	R/P	R/P	R/P	R/P	R/P	
23:16	FWDTEN	WINDIS	_		WDTPS<4:0>				
45.0	R/P	R/P	R/P	R/P	r-1	R/P	R/P	R/P	
15:8	FCKSM	1<1:0>	FPBDI	/<1:0> —		OSCIOFNC	POSCM	OD<1:0>	
7.0	R/P	r-1	R/P	r-1	r-1	R/P	R/P	R/P	
7:0	IESO	_	FSOSCEN	_	—	F	NOSC<2:0>		

REGISTER 27-2: DEVCFG1: DEVICE CONFIGURATION WORD 1

Legend:	r = Reserved bit	P = Programmable bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'		
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

bit 31-26 Reserved: Write '1'

bit 25-24 FWDTWINSZ<1:0>: Watchdog Timer Window Size bits

- 11 = Window size is 25%
- 10 = Window size is 37.5%
- 01 = Window size is 50%
- 00 = Window size is 75%

bit 23 FWDTEN: Watchdog Timer Enable bit

- 1 = Watchdog Timer is enabled and cannot be disabled by software
- 0 = Watchdog Timer is not enabled; it can be enabled in software

bit 22 WINDIS: Watchdog Timer Window Enable bit

- 1 = Watchdog Timer is in non-Window mode
- 0 = Watchdog Timer is in Window mode

bit 21 Reserved: Write '1'

bit 20-16 WDTPS<4:0>: Watchdog Timer Postscale Select bits

10100 = 1:1048576
10011 = 1:524288
10010 = 1:262144
10001 = 1:131072
10000 = 1:65536
01111 = 1:32768
01110 = 1:16384
01101 = 1:8192
01100 = 1:4096
01011 = 1:2048
01010 = 1:1024
01001 = 1:512
01000 = 1:256
00111 = 1:128
00110 = 1:64
00101 = 1:32
00100 = 1:16
00011 = 1:8
00010 = 1 :4
00001 = 1:2
00000 = 1:1
All other combinations not shown result in operation = 10100
······································

Note 1: Do not disable the Posc (POSCMOD = 11) when using this oscillator source.

REGISTER 27-2: DEVCFG1: DEVICE CONFIGURATION WORD 1 (CONTINUED)

bit 15-14 FCKSM<1:0>: Clock Switching and Monitor Selection Configuration bits

- 1x = Clock switching is disabled, Fail-Safe Clock Monitor is disabled
- 01 = Clock switching is enabled, Fail-Safe Clock Monitor is disabled
- 00 = Clock switching is enabled, Fail-Safe Clock Monitor is enabled
- bit 13-12 FPBDIV<1:0>: Peripheral Bus Clock Divisor Default Value bits
 - 11 = PBCLK is SYSCLK divided by 8
 - 10 = PBCLK is SYSCLK divided by 4
 - 01 = PBCLK is SYSCLK divided by 2
 - 00 = PBCLK is SYSCLK divided by 1
- bit 11 Reserved: Write '1'
- bit 10 OSCIOFNC: CLKO Enable Configuration bit
 - 1 = CLKO output disabled
 - 0 = CLKO output signal active on the OSCO pin; Primary Oscillator must be disabled or configured for the External Clock mode (EC) for the CLKO to be active (POSCMOD<1:0> = 11 or 00)

bit 9-8 **POSCMOD<1:0>:** Primary Oscillator Configuration bits

- 11 = Primary Oscillator is disabled
- 10 = HS Oscillator mode is selected
- 01 = XT Oscillator mode is selected
- 00 = External Clock mode is selected
- bit 7 IESO: Internal External Switchover bit
 - 1 = Internal External Switchover mode is enabled (Two-Speed Start-up is enabled)
 - 0 = Internal External Switchover mode is disabled (Two-Speed Start-up is disabled)
- bit 6 **Reserved:** Write '1'
- bit 5 **FSOSCEN:** Secondary Oscillator Enable bit
 - 1 = Enable Secondary Oscillator
 - 0 = Disable Secondary Oscillator
- bit 4-3 Reserved: Write '1'
- bit 2-0 **FNOSC<2:0>:** Oscillator Selection bits
 - 111 = Fast RC Oscillator with divide-by-N (FRCDIV)
 - 110 = FRCDIV16 Fast RC Oscillator with fixed divide-by-16 postscaler
 - 101 = Low-Power RC Oscillator (LPRC)
 - 100 = Secondary Oscillator (Sosc)
 - 011 = Primary Oscillator (Posc) with PLL module (XT+PLL, HS+PLL, EC+PLL)
 - 010 = Primary Oscillator (XT, HS, EC)⁽¹⁾
 - 001 = Fast RC Oscillator with divide-by-N with PLL module (FRCDIV+PLL)
 - 000 = Fast RC Oscillator (FRC)
- **Note 1:** Do not disable the Posc (POSCMOD = 11) when using this oscillator source.

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0	
24.04	R/P	R/P	R/P	R/P	r-1	r-1	r-1	r-1	
31:24	FVBUSONIO	FUSBIDIO	IOL1WAY	PMDL1WAY	_		_	_	
23:16	r-1	r-1	r-1	r-1	r-1	r-1	r-1	r-1	
23.10	—	—	_	—	_	_	-	_	
15.0	R/P	R/P	R/P	R/P	R/P	R/P	R/P	R/P	
15:8	USERID<15:8>								
7.0	R/P	R/P	R/P	R/P	R/P	R/P	R/P	R/P	
7:0				USERID<	7:0>				

REGISTER 27-4: DEVCFG3: DEVICE CONFIGURATION WORD 3

Legend:	r = Reserved bit	P = Programmable bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit,	read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

bit 31 FVBUSONIO: USB VBUSON Selection bit

- 1 = VBUSON pin is controlled by the USB module 0 = VBUSON pin is controlled by the port function
- bit 30 **FUSBIDIO:** USB USBID Selection bit 1 = USBID pin is controlled by the USB module 0 = USBID pin is controlled by the port function
- bit 29 IOL1WAY: Peripheral Pin Select Configuration bit
 - 1 = Allow only one reconfiguration
 - 0 = Allow multiple reconfigurations
- bit 28 PMDI1WAY: Peripheral Module Disable Configuration bit
 - 1 = Allow only one reconfiguration
 - 0 = Allow multiple reconfigurations
- bit 27-16 Reserved: Write '1'
- bit 15-0 USERID<15:0>: User ID bits

This is a 16-bit value that is user-defined and is readable via ICSP™ and JTAG.

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0	
	R	R	R	R	R	R	R	R	
31:24		VER<	3:0> ⁽¹⁾			DEVID<	27:24> ⁽¹⁾		
00.40	R	R	R	R	R	R	R	R	
23:16	DEVID<23:16> ⁽¹⁾								
45.0	R	R	R	R	R	R	R	R	
15:8	DEVID<15:8> ⁽¹⁾								
7.0	R	R	R	R	R	R	R	R	
7:0				DEVID	<7:0>(1)				

REGISTER 27-6: DEVID: DEVICE AND REVISION ID REGISTER

Legend:

Legena.			
R = Readable bit	W = Writable bit	U = Unimplemented bit,	read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-28 VER<3:0>: Revision Identifier bits⁽¹⁾

bit 27-0 DEVID<27:0>: Device ID bits⁽¹⁾

Note 1: See the "*PIC32 Flash Programming Specification*" (DS60001145) for a list of Revision and Device ID values.

28.0 INSTRUCTION SET

The PIC32MX1XX/2XX family instruction set complies with the MIPS32[®] Release 2 instruction set architecture. The PIC32 device family does not support the following features:

- · Core extend instructions
- Coprocessor 1 instructions
- Coprocessor 2 instructions

Note: Refer to *"MIPS32[®] Architecture for Programmers Volume II: The MIPS32[®] Instruction Set"* at www.imgtec.com for more information.

TABLE 30-32: I2Cx BUS DATA TIMING REQUIREMENTS (MASTER MODE)

AC CHA		ISTICS		$\label{eq:standard} \begin{array}{l} \mbox{Standard Operating Conditions: 2.3V to 3.6V} \\ \mbox{(unless otherwise stated)} \\ \mbox{Operating temperature} & -40^\circ C \leq TA \leq +85^\circ C \mbox{ for Industrial} \\ -40^\circ C \leq TA \leq +105^\circ C \mbox{ for V-temp} \end{array}$					
Param. No.	Symbol	Charact	eristics	Min. ⁽¹⁾	Max.	Units	Conditions		
IM10 TLO:SCL		Clock Low Time	100 kHz mode	Трв * (BRG + 2)	—	μS	—		
			400 kHz mode	Трв * (BRG + 2)	_	μS	—		
			1 MHz mode (Note 2)	Трв * (BRG + 2)	_	μs	_		
IM11	THI:SCL	Clock High Time	100 kHz mode	Трв * (BRG + 2)	_	μS	—		
			400 kHz mode	Трв * (BRG + 2)	—	μS	—		
			1 MHz mode (Note 2)	Трв * (BRG + 2)	—	μs	—		
IM20	TF:SCL	SDAx and SCLx	100 kHz mode	—	300	ns	CB is specified to be		
		Fall Time	400 kHz mode	20 + 0.1 Св	300	ns	from 10 to 400 pF		
			1 MHz mode (Note 2)	_	100	ns			
IM21 TR:SCL	TR:SCL	SDAx and SCLx Rise Time	100 kHz mode	—	1000	ns	CB is specified to be		
			400 kHz mode	20 + 0.1 Св	300	ns	from 10 to 400 pF		
			1 MHz mode (Note 2)	_	300	ns			
IM25 TSU:DAT	TSU:DAT	Data Input Setup Time	100 kHz mode	250	_	ns	—		
			400 kHz mode	100	—	ns			
			1 MHz mode (Note 2)	100	_	ns			
IM26	THD:DAT	Data Input Hold Time	100 kHz mode	0	_	μS	—		
			400 kHz mode	0	0.9	μs			
			1 MHz mode (Note 2)	0	0.3	μs			
IM30	TSU:STA	STA Start Condition Setup Time	100 kHz mode	Трв * (BRG + 2)	_	μS	Only relevant for		
			400 kHz mode	Трв * (BRG + 2)	—	μS	Repeated Start condition		
			1 MHz mode (Note 2)	Трв * (BRG + 2)	—	μs	condition		
IM31	THD:STA	ID:STA Start Condition Hold Time	100 kHz mode	Трв * (BRG + 2)		μS	After this period, the		
			400 kHz mode	Трв * (BRG + 2)	—	μS	first clock pulse is generated		
			1 MHz mode (Note 2)	Трв * (BRG + 2)	—	μS	generaleu		
IM33 Tsu:st	Tsu:sto	Stop Condition Setup Time	100 kHz mode	Трв * (BRG + 2)		μS			
			400 kHz mode	Трв * (BRG + 2)		μs			
			1 MHz mode (Note 2)	Трв * (BRG + 2)		μs			
IM34	THD:STO	Stop Condition	100 kHz mode	Трв * (BRG + 2)		ns	—		
		Hold Time	400 kHz mode	Трв * (BRG + 2)		ns]		
			1 MHz mode (Note 2)		—	ns			

Note 1: BRG is the value of the I^2C Baud Rate Generator.

2: Maximum pin capacitance = 10 pF for all I2Cx pins (for 1 MHz mode only).

3: The typical value for this parameter is 104 ns.

TABLE 30-32:	I2Cx BUS DATA	TIMING REQUIREMENTS	(MASTER MODE)	(CONTINUED)

AC CHARACTERISTICS				$\begin{array}{l} \mbox{Standard Operating Conditions: 2.3V to 3.6V} \\ \mbox{(unless otherwise stated)} \\ \mbox{Operating temperature} & -40^{\circ}C \leq TA \leq +85^{\circ}C \mbox{ for Industrial} \\ -40^{\circ}C \leq TA \leq +105^{\circ}C \mbox{ for V-temp} \end{array}$				
Param. No. Symbol Characteristics				Min. ⁽¹⁾	Max.	Units	Conditions	
IM40	140 TAA:SCL Output Valid	Output Valid	100 kHz mode	—	3500	ns	—	
	from Clock	400 kHz mode	—	1000	ns	—		
			1 MHz mode (Note 2)	—	350	ns	—	
IM45	5 TBF:SDA Bus Free Time		100 kHz mode	4.7	_	μS	The amount of time the	
				400 kHz mode	1.3	—	μS	bus must be free
			1 MHz mode (Note 2)	0.5	—	μS	before a new transmission can start	
IM50	Св	Bus Capacitive L	oading	—	400	pF	—	
IM51	Tpgd	Pulse Gobbler D	elay	52	312	ns	See Note 3	

Note 1: BRG is the value of the I^2C Baud Rate Generator.

2: Maximum pin capacitance = 10 pF for all I2Cx pins (for 1 MHz mode only).

3: The typical value for this parameter is 104 ns.

TABLE 31-3: DC CHARACTERISTICS: IDLE CURRENT (IIDLE)

DC CHARACT	OC CHARACTERISTICS			perating Conditions: 2.3V to 3.6V erwise stated) mperature $-40^{\circ}C \le TA \le +85^{\circ}C$ for Industrial			
Parameter No.	Typical ⁽²⁾	Max.	Units	Conditions			
Idle Current (IIDLE): Core Off, Clock on Base Current (Note 1)							
MDC34a	8	13	mA 50 MHz				

Note 1: The test conditions for IIDLE current measurements are as follows:

- Oscillator mode is EC (for 8 MHz and below) and EC+PLL (for above 8 MHz) with OSC1 driven by external square wave from rail-to-rail, (OSC1 input clock input over/undershoot < 100 mV required)
- OSC2/CLKO is configured as an I/O input pin
- USB PLL oscillator is disabled if the USB module is implemented, PBCLK divisor = 1:8
- CPU is in Idle mode (CPU core Halted), and SRAM data memory Wait states = 1
- No peripheral modules are operating, (ON bit = 0), but the associated PMD bit is cleared
- WDT, Clock Switching, Fail-Safe Clock Monitor, and Secondary Oscillator are disabled
- All I/O pins are configured as inputs and pulled to Vss
- MCLR = VDD
- RTCC and JTAG are disabled
- 2: Data in the "Typical" column is at 3.3V, 25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

DC CHAR	DC CHARACTERISTICSStandard Operating Conditions: 2.3V to 3.6V (unless otherw Operating temperature $-40^{\circ}C \le TA \le +85^{\circ}C$ for Industrial							
Param. No.	Typical ⁽²⁾	Max.	Units	Conditions				
Power-Down Current (IPD) (Note 1)								
MDC40k	10	25	μA	-40°C	Base Power-Down Current			
MDC40n	250	500	μA	+85°C	Base Power-Down Current			
Module Differential Current								
MDC41e	10	55	μA	3.6V Watchdog Timer Current: △IwDT (Note 3)				
MDC42e	23	55	μA	3.6V	V RTCC + Timer1 w/32 kHz Crystal: ∆IRTCC (Note 3)			
MDC43d	1100	1300	μA	3.6V ADC: ΔΙΑDC (Notes 3,4)				

TABLE 31-4: DC CHARACTERISTICS: POWER-DOWN CURRENT (IPD)

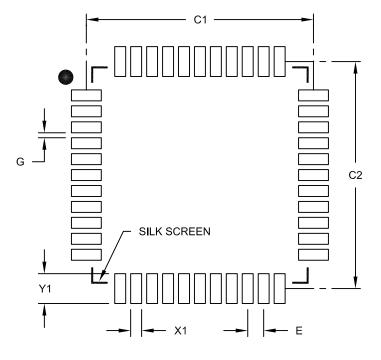
Note 1: The test conditions for IPD current measurements are as follows:

• Oscillator mode is EC (for 8 MHz and below) and EC+PLL (for above 8 MHz) with OSC1 driven by external square wave from rail-to-rail, (OSC1 input clock input over/undershoot < 100 mV required)

- · OSC2/CLKO is configured as an I/O input pin
- USB PLL oscillator is disabled if the USB module is implemented, PBCLK divisor = 1:8
- CPU is in Sleep mode, and SRAM data memory Wait states = 1
- No peripheral modules are operating, (ON bit = 0), but the associated PMD bit is set
- WDT, Clock Switching, Fail-Safe Clock Monitor, and Secondary Oscillator are disabled
- · All I/O pins are configured as inputs and pulled to Vss
- MCLR = VDD
- RTCC and JTAG are disabled
- 2: Data in the "Typical" column is at 3.3V, 25°C unless otherwise stated. Parameters are for design guidance only and are not tested.
- **3:** The ∆ current is the additional current consumed when the module is enabled. This current should be added to the base IPD current.
- 4: Test conditions for ADC module differential current are as follows: Internal ADC RC oscillator enabled.

44-Lead Plastic Thin Quad Flatpack (PT) 10X10X1 mm Body, 2.00 mm Footprint [TQFP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



RECOMMENDED LAND PATTERN

	MILLIMETERS			
Dimension	MIN	NOM	MAX	
Contact Pitch	E		0.80 BSC	
Contact Pad Spacing	C1		11.40	
Contact Pad Spacing	C2		11.40	
Contact Pad Width (X44)	X1			0.55
Contact Pad Length (X44)	Y1			1.50
Distance Between Pads	G	0.25		

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2076B